



Tflex P300 Directions for Use

Shelf Life:

Shelf life for Tflex P300 is 2 years from date of shipment at the storage conditions specified below.

Storage Conditions:

Recommended storage conditions are 0-35°C at relative humidity of 50% maximum. Store in original product packaging until ready for use.

Application Instructions:

1. Remove PI liner side transparent liner.
2. Fold the die cut thermal pad and push the thermal pad to make it separate from diamond liner.
3. Peel off the thermal pad from the diamond embossed liner and place the pad onto the desired substrate. Note that any light visible residue on the liner will not affect thermal pad performance. A light diamond embossing on pad surface is expected and normal due to the material's high compliancy.
4. Cover the exposed thermal pad or continue the assembly process. Avoid contamination of the surface with dust and debris.

